

# LOCTITE ABLESTIK ATB 130U

August 2014

## PRODUCT DESCRIPTION

LOCTITE ABLESTIK ATB 130U provides the following product characteristics:

<b>Technology</b>	Rubberized Epoxy
<b>Appearance</b>	Transparent
<b>Cure</b>	Heat cure
<b>Product Benefits</b>	<ul style="list-style-type: none"> <li>• Non-conductive</li> <li>• Fast cure</li> <li>• Thin bondline</li> <li>• Excellent gap filling ability</li> <li>• L2/260°C performance</li> </ul>
<b>Application</b>	Die attach
<b>Filler Type</b>	Silica
<b>Typical Package Application</b>	Die to die stack
<b>Carrier Type</b>	Polyolefin
<b>Adhesive Thickness</b>	30µm
<b>Carrier Film Thickness</b>	85µm
<b>Wafer Size</b>	8 and 12 in
<b>pH</b>	3.5

LOCTITE ABLESTIK ATB 130U adhesive film is formulated for use in wafer lamination processes. It combines process ease with the proven reliability.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Work Life @ 25°C, month	1
Shelf Life @ 5°C (from date of manufacture), days	274

## TYPICAL PROCESS DATA

### Wafer Backside Lamination

Temperature, °C	65 to 70
Pressure, psi	40
Taping Duration, ft/ minute	1

### Chip Attach

Temperature, °C	100 to 120
Pressure, kg-f	0.5 to 2
Attach Duration, second	1 to 2

## TYPICAL CURING PERFORMANCE

### Cure Schedule

30 minute ramp to 120°C + 30 minutes @ 120°C

### Alternate Cure Schedule

30 minute ramp to 90°C + 30 minutes @ 90°C +  
30 minute ramp to 120°C + 30 minutes @ 120°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Coefficient of Thermal Expansion :	
Below Tg, ppm/°C	62
Above Tg, ppm/°C	238
Glass Transition Temperature (Tg) by TMA, °C	75
Thermal Conductivity, W/(m-K)	0.21
Tensile Modulus, DMTA :	
@ -65 °C	N/mm <sup>2</sup> 2,330 (psi) (337,940)
@ 25 °C	N/mm <sup>2</sup> 875 (psi) (126,880)
@ 100 °C	N/mm <sup>2</sup> 40 (psi) (5,360)
@ 150 °C	N/mm <sup>2</sup> 3.0 (psi) (385)
@ 200 °C	N/mm <sup>2</sup> 1.0 (psi) (175)
@ 250 °C	N/mm <sup>2</sup> 2.0 (psi) (230)

Extractable Ionic Content, ppm:	
Chloride (Cl-)	<10
Fluoride (F-)	<10
Sodium (Na+)	<10
Potassium (K+)	<10
Weight Loss @ 300°C, %	<1
Moisture Absorption @ Saturation, wt. % @ 85°C/85%RH	1.5

## TYPICAL PERFORMANCE OF CURED MATERIAL

### Miscellaneous

Die Shear Strength vs Temperature, kg-f:	
2.5 x 2.5 mm Si die frontside, kg-f:	
@ 25 °C	40
@ 260 °C	2

## GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

## DIRECTIONS FOR USE

1. Ensure all surfaces to be bonded are free from surface contamination.
2. Adhesive must be completely used within the product's recommended work life.
3. Remove the tape reel from the moisture-resistant package and load into the tape application machine.
4. Store unused adhesive film in the original sealed moisture-resistant package until needed.

**Storage**

These adhesive film should be stored at 5°C, in its original moisture resistant packaging. Partially used reels should be stored under dry conditions at 5°C.

To minimize moisture absorption, we recommend storing the adhesive film in the sealed moisture-resistant package until needed.

**Optimal Storage: 5°C. Storage below 5°C or greater than minus 5 °C can adversely affect product properties.**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

**Conversions**

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$

$\text{kV/mm} \times 25.4 = \text{V/mil}$

$\text{mm} / 25.4 = \text{inches}$

$\text{N} \times 0.225 = \text{lb}$

$\text{N/mm} \times 5.71 = \text{lb/in}$

$\text{N/mm}^2 \times 145 = \text{psi}$

$\text{MPa} = \text{N/mm}^2$

$\text{MPa} \times 145 = \text{psi}$

$\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$

$\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$

$\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$

$\text{mPa}\cdot\text{s} = \text{cP}$

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Reference 0.1